

# **LOCTITE ABLESTIK 2030SCM**

May 2014

## PRODUCT DESCRIPTION

LOCTITE ABLESTIK 2030SCM provides the following product characteristics:

Technology	Proprietary Hybrid Chemistry	
Appearance	Silver	
Cure	Heat cure	
рН	4.5	
Product Benefits	Snap curable	
	<ul> <li>Low stress</li> </ul>	
Application	Die attach	
Filler Type	Silver	
Key Substrates	Most metals	

LOCTITE ABLESTIK 2030SCM die attach adhesive has been formulated for use in high throughput die attach applications. This material is designed to minimize stress and resulting warpage between dissimilar surfaces. It can be used in a variety of package sizes.

#### IPC/JEDEC J-STD-709

LOCTITE ABLESTIK 2030SCM is low in halogen content and complies with the IPC/JEDEC low halogen electronic products standard.

# TYPICAL PROPERTIES OF UNCURED MATERIAL

Thixotropic Index (0.5/5 rpm)	4.6
Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	14,000
Work Life @ 25°C, hours	24
Shelf Life @ -40°C (from date of manufacture), days	365
Flash Point - See SDS	

#### **TYPICAL CURING PERFORMANCE**

# **Cure Schedule**

90 seconds @ 110°C

## **Alternate Cure Schedule**

10 seconds @ 150°C

## Weight Loss on Cure

10 x 10 mm Si die on glass slide, % 0.4

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

# TYPICAL PROPERTIES OF CURED MATERIAL

## **Physical Properties**

Thermal Conductivity	, W/(m-K)	2.3
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@ -65 °C @ 25 °C @ 150 °C @ 250 °C	N/mm² (psi) N/mm² (psi) N/mm² (psi) N/mm²	6,200 (900,000) 3,300 (480,000) 350 (50,000) 450
	(psi)	(65,000)
Extractable Ionic Content, @ 100°C ppm:		
Chloride (Cl-)		<20
Sodium (Na+)		<30
Potassium (K+)		<5
Weight Loss After Cure, %: 16 hours Isothermal @ 125°C Ramp to 230°C		0.41 0.5

## **Electrical Properties**

Tensile Modulus, DMTA:

Volume Resistivity, ohms-cm:	
cured 90 seconds @ 110°C	0.0002
Bond Joint Resistance, ohms:	
cured 90 seconds @ 110°C, Cu/Cu, 25µm Bondline	0.008

# TYPICAL PERFORMANCE OF CURED MATERIAL

Die Shear Strength vs Substrate:

2 X 2 mm die, kg-f,

Die on Substrate:	@ RT
Si die on Pd	1.90
Au die on SS	2.24
Au die on Au	2.11

Die Shear Strength vs Die Shear Temperature:

3 X 3 mm Si die, kg-f,

cured 90 seconds @ 110°C

Substrate	@25°C	@150°C	@200°C
PBGA-FR4	1.90	0.96	0.87

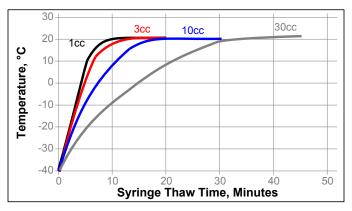
## **GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

### THAWING:

- 1. Allow container to reach room temperature before use.
- 2. After removing from the freezer, set the syringes to stand vertically while thawing.
- 3. Refer to the Syringe Thaw time chart for the thaw time recommendation.
- 4. DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to -40°C, the adhesive should not be re-frozen.





#### **DIRECTIONS FOR USE**

- Thawed material should immediately be placed on dispense equipment for use.
- If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
- Adhesive must be completely used within the product's recommended work life.
- Silver-resin separation may occur if the adhesive is left out at room temperature, beyond the recommended work life.

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

#### STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

# Conversions

 $(^{\circ}C \times 1.8) + 32 = ^{\circ}F$  kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.742 = oz·in mPa·s = cP

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